

Petition For Revival Of An Application For Patent Abandoned  
Unintentionally Under 37 CFR 1.137(b) (Large Entity)

Docket No.  
E0520CIP

In Re Application Of: K. Sahota, D. Schonauer, J. Groschopf, G. Marxsen, and S. Avanzino

Serial No.	Filing Date	Examiner	Group Art Unit
09/749,191	Dec. 26, 2000	L. Umez-Eronini	1765

Invention: Prevention of Precipitation Defects on Copper Interconnects During CMP By Use of Solutions Containing Organic Compounds With Silica Adsorption and Copper Corrosion Inhibiting Properties

Attention: Office of Petitions  
COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, VA 22313-1450

NOTE: If information or assistance is needed in completing this form, please contact Petitions Information at (703) 305-9282.

The above-identified application became abandoned for failure to file a timely and proper response to a notice or action by the Patent and Trademark Office. The date of abandonment is the day after the expiration date of the period set for reply in the Office notice or action plus any extension of time actually obtained.

**APPLICANT HEREBY PETITIONS FOR REVIVAL OF THIS APPLICATION**

NOTE: A grantable petition requires the following items:

- (1) Petition fee;
- (2) Reply and/or issue fee;
- (3) Terminal disclaimer with disclaimer fee--required for all utility and plant applications filed before June 8, 1995; and for all design applications; and
- (4) Statement that the entire delay was unintentional.

1.  A proposed reply to the above-identified notice or action:

is enclosed.  was filed on \_\_\_\_\_

The proposed reply is in the form of: Notice of Foreign Filing \_\_\_\_\_

2.  The issue fee:

is enclosed.  was paid on \_\_\_\_\_

3.  The abandoned application was a:

design application.  utility application.  plant application.

4.  A terminal disclaimer (and fee) disclaiming a period equivalent to the period of abandonment is enclosed.

5.  Since this utility/plant application was filed on or after June 8, 1995, no terminal disclaimer is required.

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**Calculation and Payment of Fees**

Enclosed are the following fees:

- |   |                   |
|---|-------------------|
| 6. <input checked="" type="checkbox"/> Petition fee under 37 CFR 1.17(m) in the amount of:          | <u>\$1,300.00</u> |
| 7. <input type="checkbox"/> Fee for amendment in the amount of:                                     | _____<br>_____    |
| 8. <input type="checkbox"/> Fee for extension of time to respond to Office Action in the amount of: | _____<br>_____    |
| 9. <input type="checkbox"/> Issue fee in the amount of:   | _____<br>_____    |
| 10. <input type="checkbox"/> Continuing application filing fee in the amount of:                    | _____<br>_____    |
| 11. <input type="checkbox"/> Terminal disclaimer fee in the amount of:                              | _____<br>_____    |
| 12. <input type="checkbox"/> _____  | _____<br>_____    |

Total fees enclosed: \$1,300.00

The fee of \$1,300 is to be paid as follows:

- A check in the amount of the fee is enclosed.  
 The Director is hereby authorized to charge any fees which may be required, or credit any overpayment, to Deposit Account No. CREDIT CARD

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Docket No.  
**E0520CIP**

In Re Application Of: **K. Sahota, D. Schonauer, J. Groschopf, G. Marxsen, and S. Avazza**

Serial No. <b>09/749,191</b>	Filing Date <b>Dec. 26, 2000</b>	Examiner <b>L. Umez-Eronini</b>	Group Art Unit <b>1765</b>
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Invention: **Prevention of Precipitation Defects on Copper Interconnects During CMP By Use of Solutions Containing Organic Compounds With Silica Adsorption and Copper Corrosion Inhibiting Properties**

**Statement**

The entire delay in filing the required reply from the due date for the required reply until the filing of a grantable petition under 37 CFR 1.137(b) was unintentional.

Deborah W. Wenocur  
Signature

Dated:

Deborah W. Wenocur, Reg. No. 40,221  
Agent for Applicant  
Advanced Micro Devices, Inc., Technology Law Dept.  
One AMD Place, M/S 68  
P.O. Box 3453  
Sunnyvale, CA 94088-3453

I certify that this document and fee is being deposited on Sept 9, 2003 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Mail Stop Petition, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Deborah W. Wenocur  
Signature of Person Mailing Correspondence

Deborah W. Wenocur

Typed or Printed Name of Person Mailing Correspondence

CC: